## 2SC1162

## Silicon NPN Epitaxial

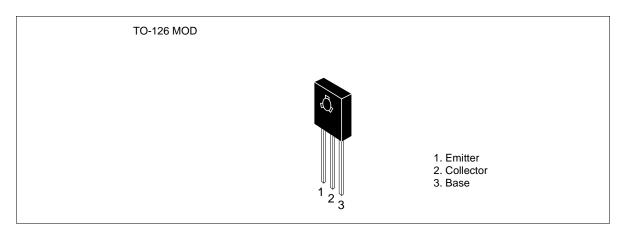
## **HITACHI**

ADE-208-880 (Z) 1st. Edition Sep. 2000

#### **Application**

Low frequency power amplifier complementary pair with 2SA715

#### **Outline**



### **Absolute Maximum Ratings** $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{\text{CBO}}$	35	V
Collector to emitter voltage	$V_{\text{CEO}}$	35	V
Emitter to base voltage	$V_{EBO}$	5	V
Collector current	I <sub>c</sub>	2.5	А
Collector peak current	I <sub>C(peak)</sub>	3	А
Collector power dissipation	P <sub>c</sub>	0.75	W
	P <sub>c</sub> *1	10	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. Value at  $T_c = 25^{\circ}C$ .



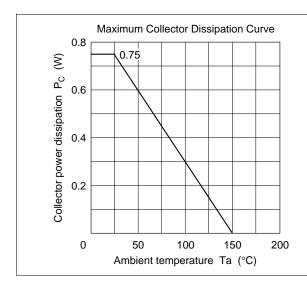
### 2SC1162

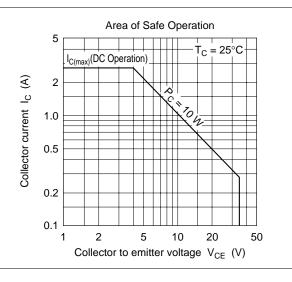
### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

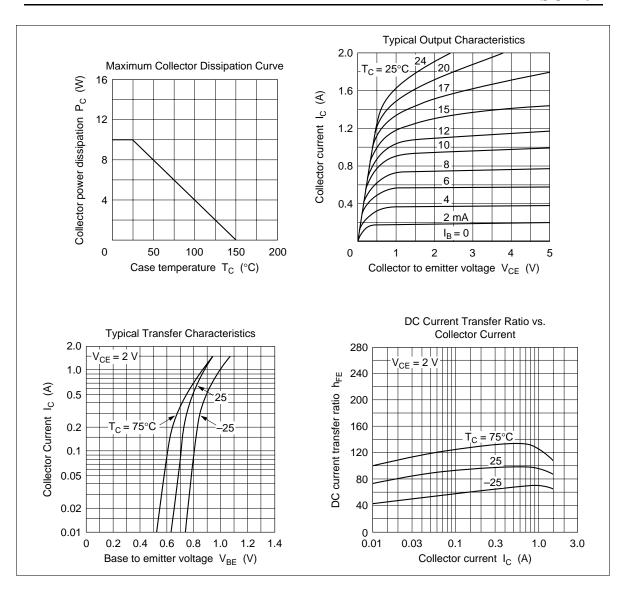
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	35	_	_	V	$I_C = 1 \text{ mA}, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	35	_	_	V	$I_{C} = 10 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_{E} = 1 \text{ mA}, I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	20	μΑ	$V_{CB} = 35 \text{ V}, I_{E} = 0$
DC current transfer ratio	h <sub>FE</sub> *1	60	_	320		$V_{CE} = 2 \text{ V}, I_{C} = 0.5 \text{ A}$
	h <sub>FE</sub>	20	_	_		$V_{CE} = 2 \text{ V}, I_{C} = 1.5 \text{ A}$ (pulse test)
Base to emitter voltage	$V_{BE}$	_	0.93	1.5	V	$V_{CE} = 2 \text{ V}, I_{C} = 1.5 \text{ A}$ (pulse test)
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	0.5	1.0	V	$I_C = 2 \text{ A}, I_B = 0.2 \text{ A (pulse test)}$
Gain bandwidth product	f <sub>T</sub>	_	180	_	MHz	$V_{CE} = 2 \text{ V}, I_{C} = 0.2 \text{ A}$

Note: 1. The 2SC1162 is grouped by  $h_{FE}$  as follows.

В	С	D
60 to 120	100 to 200	160 to 320

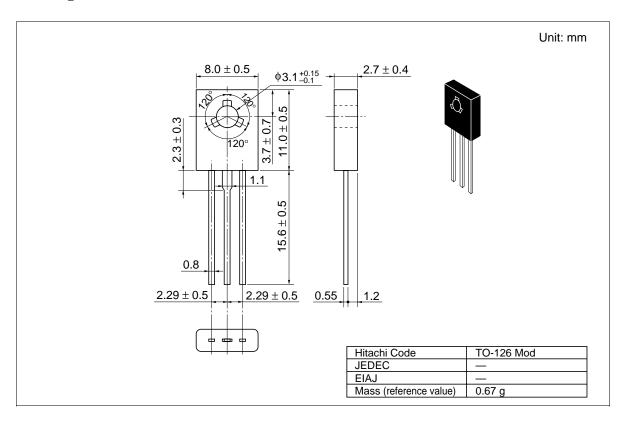






### 2SC1162

### **Package Dimensions**



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